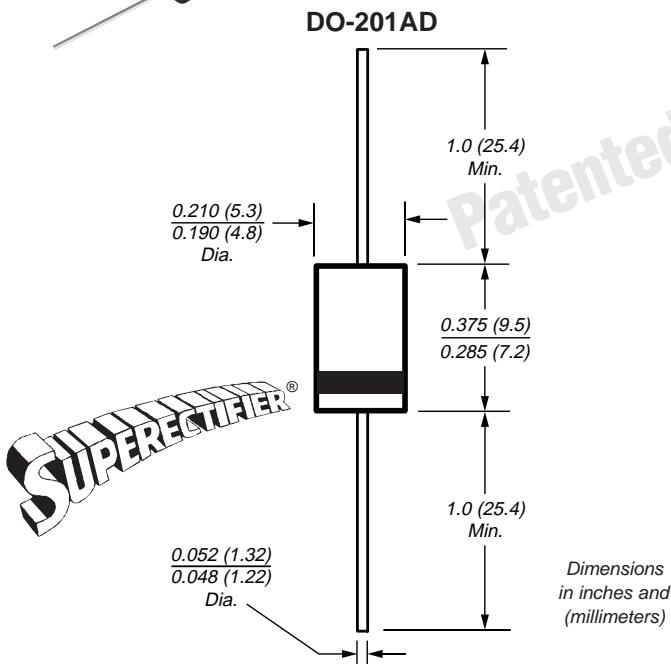




Clamper/Damper Glass Passivated Rectifier



*Glass-plastic encapsulation technique is covered by Patent No. 3,996,602 and brazed-lead assembly by Patent No. 3,930,306

Reverse Voltage 1400 to 1500V
 Forward Current 3.0A

Features

- Specially designed for clamping circuits, horizontal deflection systems and damper applications
- Plastic package has Underwriters Laboratories Flammability Classification 94V-0
- High temperature metallurgically bonded construction
- Cavity-free glass passivated junction
- 3.0 ampere operation at $T_A=50^\circ\text{C}$ with no thermal runaway
- Typical I_R less than $0.1\mu\text{A}$
- Capable of meeting environmental standards of MIL-S-19500
- High temperature soldering guaranteed: $350^\circ\text{C}/10$ seconds, 0.375" (9.5mm) lead length, 5 lbs. (2.3kg) tension

Mechanical Data

Case: JEDEC DO-201AD, molded plastic over glass body

Terminals: Plated axial leads, solderable per MIL-STD-750, Method 2026

Polarity: Color band denotes cathode end

Mounting Position: Any

Weight: 0.04 oz., 1.12 g

Packaging codes/options:

1/Bulk - 1.5K per container, 15K per box

4/1.4K per 13" reel, 5.6K per box

23/1K per ammo mag., 9K per box

Maximum Ratings & Thermal Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symbol	CGP30	DGP30	Unit
Maximum repetitive peak reverse voltage	V _{RRM}	1400	1500	V
Maximum RMS voltage	V _{RMS}	980	1050	V
Maximum DC blocking voltage	V _{DC}	1400	1500	V
Maximum average forward rectified current 0.375" (9.5mm) lead length at $T_A = 50^\circ\text{C}$	I _{F(AV)}	3.0		A
Peak forward surge current 8.3ms single half sine wave superimposed on rated load (JEDEC Method) at $T_A = 50^\circ\text{C}$	I _{FSM}	100		A
Maximum full load reverse current full cycle average 0.375" (9.5mm) lead length at $T_A = 70^\circ\text{C}$	I _{R(AV)}	200		μA
Typical thermal resistance (Note 1)	R _{θJA}	20		$^\circ\text{C/W}$
Operating junction and storage temperature range	T _J , T _{STG}	-65 to +175		°C

Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symbol	CGP30	DGP30	Unit
Maximum instantaneous forward voltage at 3.0A	V _F	1.2		V
Maximum DC reverse current $T_A = 25^\circ\text{C}$ at rated DC blocking voltage $T_A = 100^\circ\text{C}$	I _R	5.0 100		μA
Maximum reverse recovery time at $I_F = 0.5\text{A}$, $I_R = 50\text{mA}$	t _{rr}	15	20	μs
Maximum reverse recovery time at $I_F=0.5\text{A}$, $I_R=1.0\text{A}$, $I_{rr}=0.25\text{A}$	t _{rr}	1.0 2.0		μs
Typical junction capacitance at 4.0V, 1MHz	C _J	40		pF

Note: (1) Thermal resistance from junction to ambient at 0.375" (9.5mm) lead length, with leads attached to heat sink

CGP30 and DGP30



Vishay Semiconductors
formerly General Semiconductor

Ratings and Characteristic Curves ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig. 1 – Forward Current Derating Curve

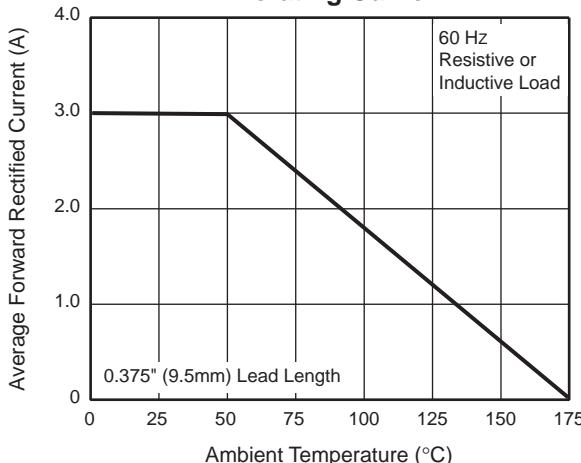


Fig. 2 – Maximum Non-Repetitive Peak Forward Surge Current

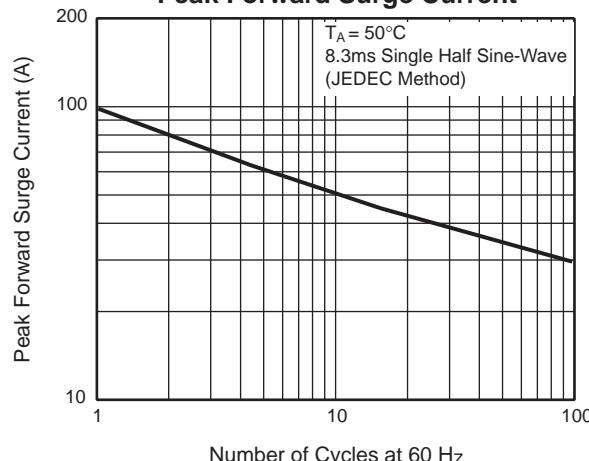


Fig. 3 – Typical Instantaneous Forward Characteristics

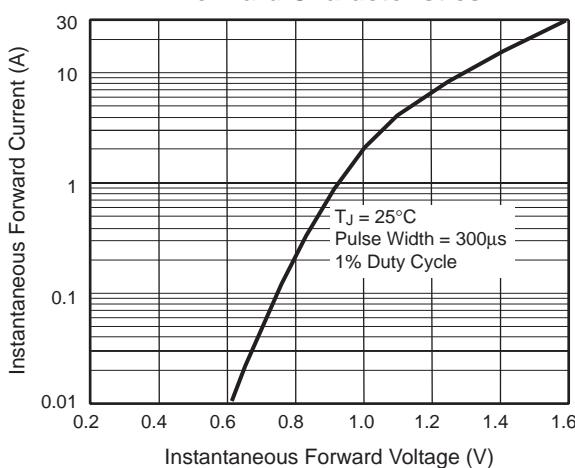


Fig. 4 – Typical Reverse Characteristics

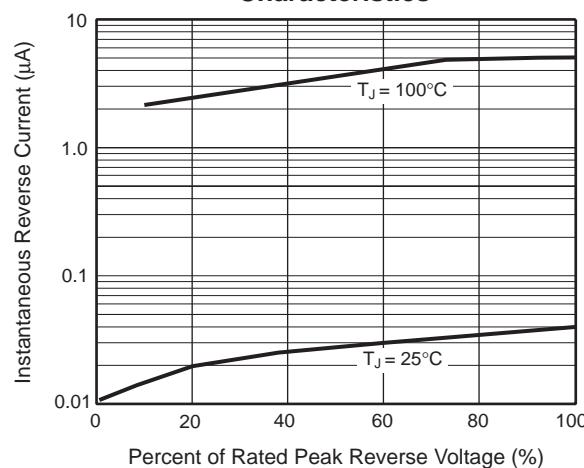


Fig. 5 – Typical Junction Capacitance

